

# **BUK7230-55A**

# N-channel TrenchMOS standard level FET Rev. 02 — 16 March 2010

**Product data sheet** 

### **Product profile**

#### 1.1 General description

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product has been designed and qualified to the appropriate AEC standard for use in automotive critical applications.

#### 1.2 Features and benefits

- Low conduction losses due to low on-state resistance
- Q101 compliant

- Suitable for standard level gate drive sources
- Suitable for thermally demanding environments due to 175 °C rating

#### 1.3 Applications

- 12 V and 24 V loads
- Automotive and general purpose power switching

Motors, lamps and solenoids

#### 1.4 Quick reference data

Table 1. **Quick reference** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{DS}$	drain-source voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}$	-	-	55	V
I <sub>D</sub>	drain current	$V_{GS} = 5 \text{ V}; T_{mb} = 25 \text{ °C};$ see Figure 1 and 3	-	-	38	Α
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	-	88	W
Avalanc	he ruggedness					
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$I_D = 34 \text{ A; } V_{sup} \le 55 \text{ V;}$ $R_{GS} = 50 \Omega; V_{GS} = 10 \text{ V;}$ $T_{j(init)} = 25 ^{\circ}C; \text{ unclamped}$	-	-	58	mJ
Dynamic	characteristics					
$Q_{GD}$	gate-drain charge	$V_{GS} = 10 \text{ V}; I_D = 25 \text{ A};$ $V_{DS} = 44 \text{ V}; \text{see } \frac{\text{Figure } 14}{\text{Figure } 14}$	-	9	-	nC
Static ch	Static characteristics					
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = 10 V; $I_D$ = 25 A; $T_j$ = 25 °C; see <u>Figure 11</u> and <u>12</u>	-	26	30	mΩ



# 2. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol		
1	G	gate				
2	D	drain	mb	D		
3	S	source				
mb	D	mounting base; connected to drain	1 3	mbb076 S		
			SOT428 (DPAK)			

# 3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BUK7230-55A	DPAK	plastic single-ended surface-mounted package (DPAK); 3 leads (one lead cropped)	SOT428

# 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{DS}$	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C		-	55	V
$V_{DGR}$	drain-gate voltage	$R_{GS} = 20 \text{ k}\Omega$		-	55	V
$V_{GS}$	gate-source voltage			-20	20	V
I <sub>D</sub>	drain current	$T_{mb}$ = 25 °C; $V_{GS}$ = 5 V; see <u>Figure 1</u> and <u>3</u>		-	38	Α
		$T_{mb}$ = 100 °C; $V_{GS}$ = 5 V; see <u>Figure 1</u>		-	27	Α
$I_{DM}$	peak drain current	$T_{mb}$ = 25 °C; $t_p \le 10 \mu s$ ; pulsed; see <u>Figure 3</u>	<u>[1]</u>	-	150	Α
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>		-	88	W
T <sub>stg</sub>	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-dr	ain diode					
Is	source current	T <sub>mb</sub> = 25 °C		-	38	Α
I <sub>SM</sub>	peak source current	$t_p \le 10 \mu\text{s}; \text{ pulsed};  T_{mb} = 25 ^{\circ}\text{C}$		-	150	Α
Avalanche	ruggedness					
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$I_D$ = 34 A; $V_{sup} \le$ 55 V; $R_{GS}$ = 50 $\Omega$ ; $V_{GS}$ = 10 V; $T_{j(init)}$ = 25 °C; unclamped		-	58	mJ

<sup>[1]</sup> Peak drain current is limited by chip, not package.

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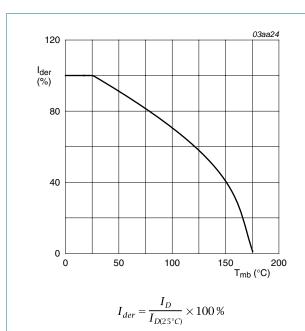
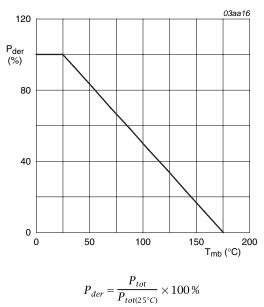
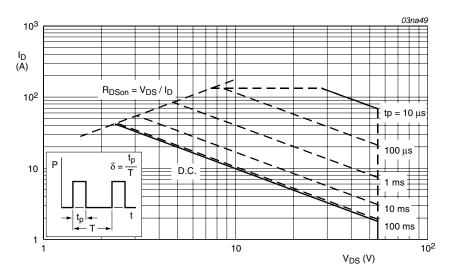


Fig 1. Normalized continuous drain current as a function of mounting base temperature



Normalized total power dissipation as a Fig 2. function of mounting base temperature



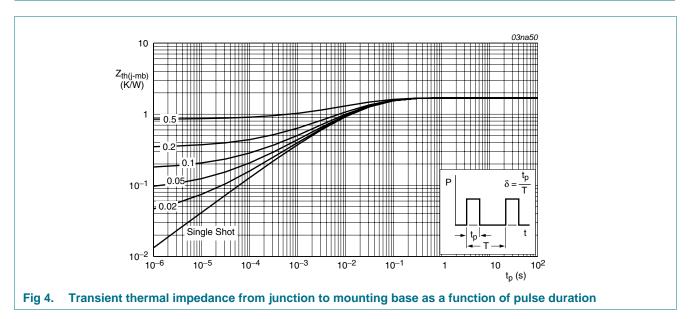
 $T_{amb} = 25$ °C;  $I_{DM}$  is single pulse

Fig 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

### 5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base		-	-	1.7	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	see Figure 4	-	71.4	-	K/W



# 6. Characteristics

Table 6. Characteristics

Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V <sub>(BR)DSS</sub> drain-source breakdown vo		$I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	55	-	-	V
	breakdown voltage	$I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = -55 \text{ °C}$	50	-	-	V
V <sub>GS(th)</sub>	gate-source threshold	$I_D = 1 \text{ mA}$ ; $V_{DS} = V_{GS}$ ; $T_j = 25 \text{ °C}$ ; see <u>Figure 10</u>	2	3	4	V
	voltage	$I_D = 1 \text{ mA}$ ; $V_{DS} = V_{GS}$ ; $T_j = -55 \text{ °C}$ ; see Figure 10	-	-	4.4	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C}; \text{ see } \frac{\text{Figure } 10}{\text{ or } 10}$	1	-	-	V
I <sub>DSS</sub>	drain leakage current	$V_{DS} = 55 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 175 \text{ °C}$	-	-	500	μΑ
		$V_{DS} = 55 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	0.05	10	μΑ
I <sub>GSS</sub>	gate leakage current	$V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V}; T_j = 25 \text{ °C}$	-	2	100	nA
		$V_{DS} = 0 \text{ V}; V_{GS} = -10 \text{ V}; T_j = 25 \text{ °C}$	-	2	100	nA
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 25 \text{ A}; T_j = 175 ^{\circ}\text{C}; \text{see } \frac{\text{Figure 11}}{\text{and } \frac{12}{\text{C}}}$	-	-	60	mΩ
		$V_{GS}$ = 10 V; $I_D$ = 25 A; $T_j$ = 25 °C; see <u>Figure 11</u> and <u>12</u>	-	26	30	mΩ
Dynamic	characteristics					
Q <sub>G(tot)</sub>	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 44 \text{ V}; V_{GS} = 10 \text{ V}; \text{ see } \frac{\text{Figure } 14}{\text{Model}}$	-	24	-	nC
$Q_{GS}$	gate-source charge		-	5	-	nC
$Q_{GD}$	gate-drain charge			9	-	nC
C <sub>iss</sub>	input capacitance	$V_{GS} = 0 \text{ V; } V_{DS} = 25 \text{ V; } f = 1 \text{ MHz; } T_j = 25 \text{ °C;}$ see Figure 15		864	1152	рF
C <sub>oss</sub>	output capacitance			218	262	pF
$C_{rss}$	reverse transfer capacitance		-	139	191	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS} = 30 \text{ V}; R_L = 1.2 \Omega; V_{GS} = 5 \text{ V};$	-	14	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 10 \Omega; T_j = 25 °C$	-	68	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	83	-	ns
t <sub>f</sub>	fall time		-	43	-	ns
L <sub>D</sub>	internal drain inductance	measured from drain lead from package to centre of die; $T_j = 25$ °C	-	2.5	-	nΗ
L <sub>S</sub>	internal source inductance	measured from drain lead from package to source bond pad	-	7.5	-	nΗ
Source-di	rain diode					
$V_{SD}$	source-drain voltage	$I_S = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 ^{\circ}\text{C}; \text{ see } \frac{\text{Figure } 13}{}$	-	0.85	1.2	V
t <sub>rr</sub>	reverse recovery time	$I_S = 25 \text{ A}$ ; $dI_S/dt = -100 \text{ A/}\mu\text{s}$ ; $V_{GS} = -10 \text{ V}$ ;	-	40	-	ns
Qr	recovered charge	$V_{DS} = 30 \text{ V; } T_j = 25 \text{ °C}$	-	100	-	nC
	<del>-</del>					

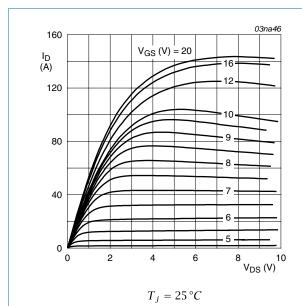


Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values

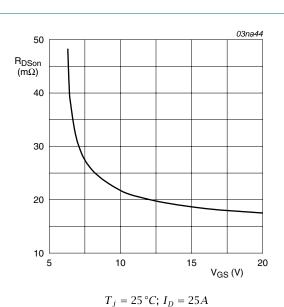


Fig 6. Drain-source on-state resistance as a function of gate-source voltage; typical values

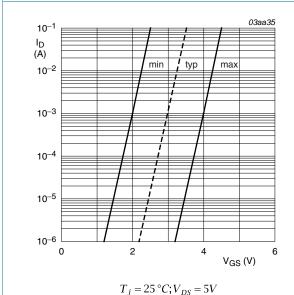
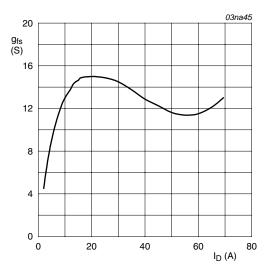


Fig 7. Sub-threshold drain current as a function of gate-source voltage



 $T_j = 25 \,^{\circ}C; \ V_{DS} = 25 \,^{\circ}V$ 

Fig 8. Forward transconductance as a function of drain current; typical values

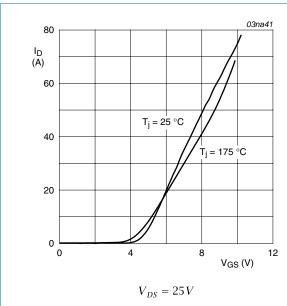


Fig 9. Transfer characteristics: drain current as a function of gate-source voltage; typical values

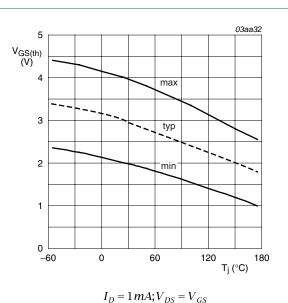


Fig 10. Gate-source threshold voltage as a function of

junction temperature

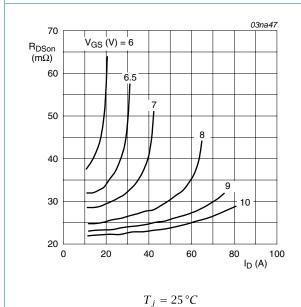


Fig 11. Drain-source on-state resistance as a function of drain current; typical values

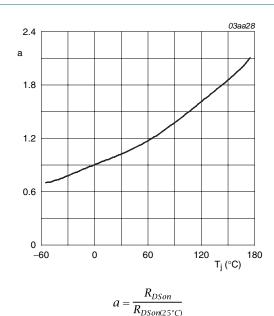


Fig 12. Normalized drain-source on-state resistance factor as a function of junction temperature

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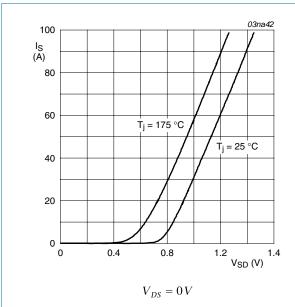
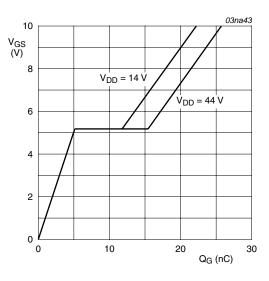
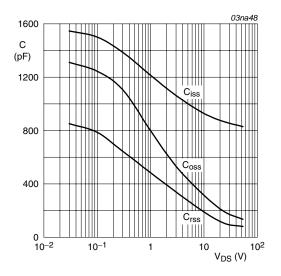


Fig 13. Reverse diode current; typical values



 $T_j = 25 \,{}^{\circ}C; I_D = 25A$ 

Fig 14. Turn-on gate charge characteristics; typical values



 $V_{GS} = 0V; f = 1MHz$ 

Fig 15. Input and reverse transfer capacitances as a function of gate-source voltage; typical values

### 7. Package outline

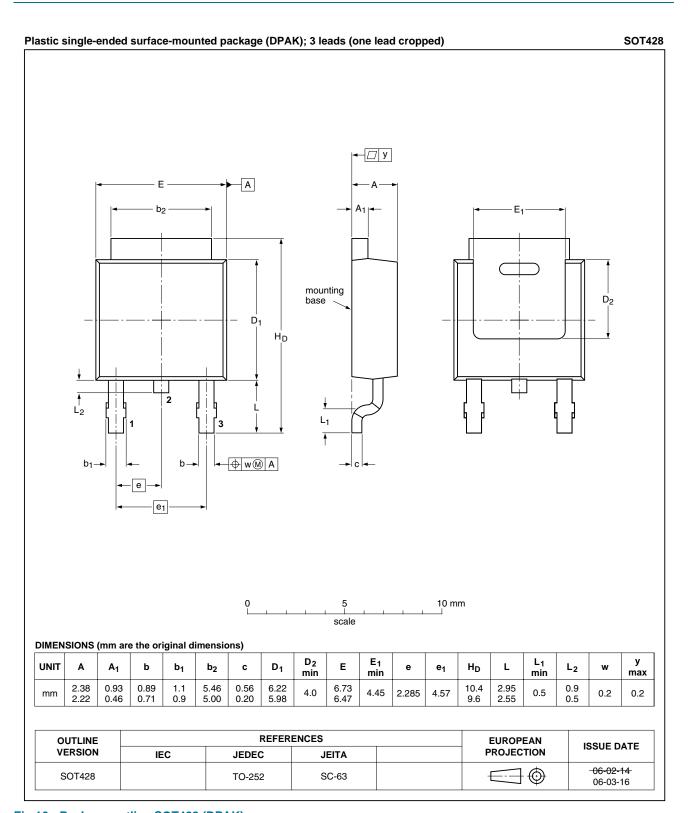


Fig 16. Package outline SOT428 (DPAK)

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# 8. Revision history

#### Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BUK7230-55A_2	20100316	Product data sheet	-	BUK7230_55A-01
Modifications:  • The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.				ly with the new identity
	<ul> <li>Legal text</li> </ul>	s have been adapted to th	e new company name v	where appropriate.
BUK7230_55A-01	20000929	Product specification	-	-

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Document status [1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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